Novo® Series: Model 102

Selective Soldering Platform with Compact Footprint and Outstanding Value



The Novo® 102 is a robust selective soldering platform delivering an exceptional combination of versatility, productivity and value. The Novo® 102 has many unique features, including high speed Z-axis motion for faster processing time and reduced soldering cycle.

Flexibility. With its feature rich, graphics-based programming and machine control software, the Novo® 102 is specially designed for demanding selective soldering applications. Set-up and time to first article is significantly reduced to within 10-15 minutes. The SWAK-OS 4.0 software features seamless fiducial recognition, live teach camera, real time data collection, SQL backend data extraction and complete FIS capability for shop floor integration.



SWAK-OS 4.0 graphics-based programming software

Features and Benefits

- Selective soldering of printed circuit boards as large as 406 x
 406 mm (16.0 x 16.0 in.)
- Standalone platform ideal for prototype, cell manufacturing or batch production requirements
- Interchangeable solder pots and pumps compatible with tinlead, lead-free and HMP solder alloys
- Choice of single selective solder nozzle, dual selective nozzles with independent control or 75 mm wide wave soldering nozzle
- SWAK-OS 4.0 graphics-based programming and machine control software enables fast and straightforward program creation

Soldering Technology. With its flexible configuration, the Novo® 102 is a versatile selective soldering platform capable of processing tin-lead, lead-free or HMP solder alloys. Interchangeable solder pots and pumps are available with either single selective solder nozzle, dual selective nozzles with independent control or 75 mm (3.0 in.) wide wave soldering nozzle. The nitrogen inerted dual nozzle system enables the use of multiple size nozzles within the same program further enhancing flexibility and productivity.

Process Control. Nordson SELECT's closed-loop rotary encoders and other advanced process control capabilities have been incorporated into the Novo® 102, enhancing solder quality, precision and yield capabilities.

Value. With a reputation for innovation, comprehensive process solutions from Nordson SELECT ensure a maximum return on investment and low cost of ownership. From initial process development through full-scale production, you are supported by our experienced worldwide engineering, applications development and technical service network.



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Novo® 102 Features

The Novo® 102 is a fully configured selective soldering platform and is a reliable and cost-effective solution for many demanding through-hole and SMT mixed-technology soldering applications including:

- Printed circuit board assemblies and other solderable substrates
- Interchangeable tin-lead and lead-free soldering



Standard Features

Universal PCB location rails with motor driven adjustment and multiple board stops for processing several boards at one time

High speed Z-axis motion

Closed-loop rotary encoders

Atomizing spray flux applicator

Tin-lead solder pot and pump assembly with 6 mm and 12 mm quick change magnetically coupled ControlFlow nozzles

Automatic wave height monitoring and adjust system

Solder alloy verification system

Heated nitrogen inerting system

Fiducial alignment and programming camera

Process viewing camera

SWAK-OS 4.0 graphics-based programming and machine control software

- Fully-automated fiducial alignment and board mapping
- Board warp compensation
- On-board help videos
- Remote machine diagnostics
- Complete FIS capability

Offline programming software

Single monitor

Optional Features

Universal PCB location fixture

FluxJet precision drop-jet dispenser

In-process flux verification system for drop-jet

Dual flux heads, 2 atomizing spray heads, 2 FluxJet drop-jet

flux dispensers or one of each

Topside infrared preheater with closed-loop control

Dual process viewing cameras

Automatic solder nozzle tinning system

Automatic solder pot level monitoring and fill system

Lead-free solder pot and pump assembly (titanium)

HMP solder pot and pump assembly

Dual nozzle solder pot and pump assembly, tin-lead or lead-free (titanium)

3-25 mm ControlFlow nozzles or 4-25 mm mini-wave nozzles 75 mm (3.0 in.) wide wave nozzle and pump assembly, tin-lead or lead-free (titanium)

2.27 kg (5.0 lbs.) solder feeder

Solder pot exchange cart with warming controls

Nitrogen de-bridging knife

Dual monitors

Six channel thermal data

logging system

Barcode reader



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Specifications

Motion System

Z accuracy (1): $\pm 50 \, \mu m \, (0.002 \, in.)$

Z repeatability $^{(2)}$: $\pm 50 \ \mu m \ (0.002 \ in.), 3 \ sigma$ Z velocity: $0.15 \ m/s \ peak \ (6 \ in./s)$ X-Y accuracy $^{(1)}$: $\pm 50 \ \mu m \ (0.002 \ in.)$

X-Y repeatability $^{(2)}$: $\pm 50 \mu m$ (0.002 in.), 3 sigma X-Y velocity: $\pm 50 \mu m$ (0.002 in.), 3 sigma

Computer

PC with Windows® operating system

Software

SWAK-OS 4.0 graphics-based programming and ma-

chine control software

Solder Pot Capacity and Weight

Capacity (3): Approx. 13.6 kg

(30.0 lbs.)

Total weight of tin-lead

solder together with solder pot

and pump assembly (3): Approx. 24.0 kg

(53.0 lbs.)

Total weight of lead-free solder

together with solder pot and

pump assembly (3): Approx. 21.3 kg

(47.0 lbs.)

Max. tin-lead/

lead-free temperature: 350°C Max. HMP temperature: 400°C

Solderable Area (X-Y)

Single ControlFlow, dual ControlFlow or mini-wave

nozzles (4, 5, 6):

Max. 406 x 406 mm (16.0 x 16.0 in.) Min. 50 x 50 mm (2.0 x 2.0 in.)

Preheating

Scalable infrared preheating from 1.0 kW to 3.0 kW

Board Handling Capability

Max. board size: 406 x 406 mm (16.0 x 16.0 in.) Min. board size: 50 x 50 mm (2.0 x 2.0 in.)

Board Clearance

Max. overboard clearance: 102 mm (4.0 in.) Max. underboard clearance: 102 mm (4.0 in.) **Facilities Requirements**

System footprint: 1194 x 1411 mm (47.0 x 55.5 in.)

Compressed Air: 6 bar (90 psi.) min.,

7 bar (100 psi) max.

Power (mains)⁽⁷⁾: Power supply accommodates

208/220-240VAC, 60 Hz

single phase, 30 A

Nitrogen (8): 99.999% (5.0) pure,

4-7 bar (60-100 psi)

1.2 m3/hour consumption

Ventilation: 595 m3/hour (350 SCFM),

two 100 mm (4.0 in.) dia. ducts

System weight (9, 10): 381 kg (840 lbs.)

(1) Accuracy as measured at extremes of travel.

(2) Repeatability is measured at full rated system speed.

(3) Solder capacity and total weight of solder pot and pump assembly varies depending on solder alloy.

(4) Substrates as small as $50 \times 50 \text{ mm}$ (2.0 x 2.0 in.) are possible without the need for fixturing or other tooling.

(5) Contact factory regarding smaller boards/carriers.

(6) 2.27 kg (5.0 lbs.) solder feeder is not compatible with dual nozzle solder pot and pump assembly.

 Electrical power varies depending on configuration.

(8) Nitrogen consumption is solder nozzle dependent and machine configuration dependent.

 System weight varies depending on configuration.

configuration.

(10) Configuration dependent. Other configurations may be available.Contact Nordson SELECT.

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Standards Compliance

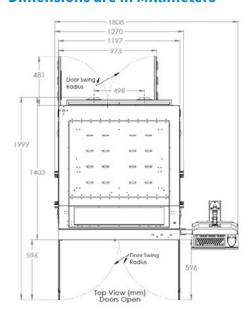
SMEMA

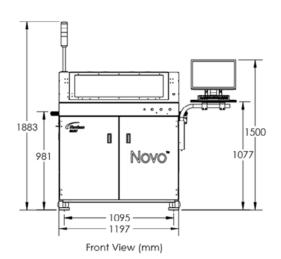
Additional options may be available: contact Nordson SELECT for further information.

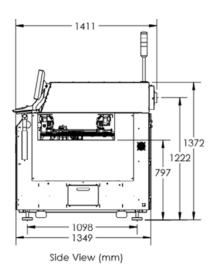


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Dimensions are in Millimeters







For more information speak with your local sales rep or contact your regional office.

nordsonselect.com

Europe

Hagenbach, Germany

+49.7273.949466.0 **Phone**

sales.eu@nordsonselect.com

Nordson SELECT GmbH Perläckerstraße 11 76767 Hagenbach

Maastricht, Netherlands +31.43.352.4466 Phone info.eu@nordsonselect.com

North America

Headquarters Liberty Lake, WA, USA +1.509.924.4898 Phone

sales.usa@nordsonselect.com

China

info.cn@nordsonselect.com

Shanghai

+86.21.3866.9166 Phone

Beijing

+86.10.8453.6388 **Phone**

Guangzhou

+86.20.8554.9996 Phone

Japan

Tokyo

+81.3.5639.7020 **Phone**

Info.japan@nordsonselect.com

Korea

Seoul

+82.31.765.8337 Phone

info.kr@nordsonselect.com

India

Chennai

+91.44.4353.9024 Phone

info.in@nordsonselect.com

S.E Asia/Australia

Singapore

+65.6796.9514 Phone

info.sg@nordsonselect.com

Taiwan

+886.229.02.1860 Phone

info.sg@nordsonselect.com

